

Form PTO 1449  
(Modified)U.S. DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICEATTY DOCKET NO.  
202321US2SERIAL NO.  
New Application

## LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Sugitaka OTEKI, et al.

FILING DATE  
Herewith

GROUP

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
<i>WA</i>	AA	5,050,221	09/17/91	Junichi OHTA, et al.			
<i>WA</i>	AB	6,041,139	03/21/00	Hiromi OKUBO, et al.			
<i>WA</i>	AC	6,151,457	11/21/00	Hiroyuki KAWAMOTO			
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES	NO
	AO					
	AP					
	AQ					
	AR					
	AS					
	AT					
	AU					
	AV					

## OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

	AW	
	AX	
	AY	
	AZ	

Examiner

Date Considered

\*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

PTO  
09/17/02  
01/29/01



LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/ Applicant</u>
202321US2*	09/770,214	01/29/01	OTEKI et al. <i>N</i>
242914US2	10/663,784	09/17/03	SHIRATA et al. <i>dl</i>

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\*Present Application; listed for information

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LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/ Applicant</u>
202321US2*	09/770,214	01/29/01	OTEKI et al. <i>NY</i>
243080US2	10/668,360	09/24/03	OHYAMA et al. <i>NY</i>

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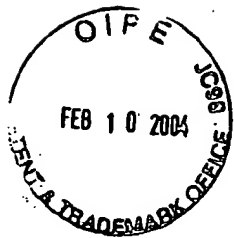
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<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/ Applicant</u>
202321US2*	09/770,214	01/29/01	OTEKI et al. <i>NU</i>
245245US2	10/703,509	11/10/03	NOMIZU et al. <i>NU</i>

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